

REF. / UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 1753

PATENT
(5298-03500/PM99021)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Lau

Serial No. 09/476,669

Filed: December 30, 1999

For: METHOD FOR FORMING A
METALLIZATION STRUCTURE IN
AN INTEGRATED CIRCUIT

Group Art Unit: 1753
Examiner: Cantelmo, G.

Atty. Dkt. No. 5298-03500

I hereby certify that this correspondence is being deposited
with the U.S. Postal Service with sufficient postage as First Class
Mail in an envelope addressed to: Max A. Commissioner for
Patents, Washington, D.C. 20231, on the date indicated below:

November 26, 2001
Date

Kevin L. Daffer

AMENDMENT; RESPONSE AFTER FINAL REJECTION
PURSUANT TO 37 CFR § 1.116

Box AF
Commissioner for Patents
Washington, D.C. 20231

Dear Sir/Madam:

This paper is submitted in response to the Office Action mailed September 26, 2001 to
further highlight reasons why the application is in condition for allowance.

Please amend the case as follows.